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|-----------------------------------|--|--|--------------------------|
| Number: | Rev: A | Designed for: Public Release | Mod. Date: 9/1/2015 |
| SVN Rev: Version control disabled | Project Title: CASCADED LMH5401 LMH6401EVM | TEXAS INSTRUMENTS | |
| Drawn By: Bob Holtz | Sheet Title: TIDA-00654 | http://www.ti.com | |
| Engineer: Rohit Bhat | Assembly Variant: 001 | File: LMH5401 LMH6401 EVM-A AMP.SchDoc | Size: B |
| | Sheet: 1 of 2 | Contact: http://www.ti.com/support | © Texas Instruments 2015 |

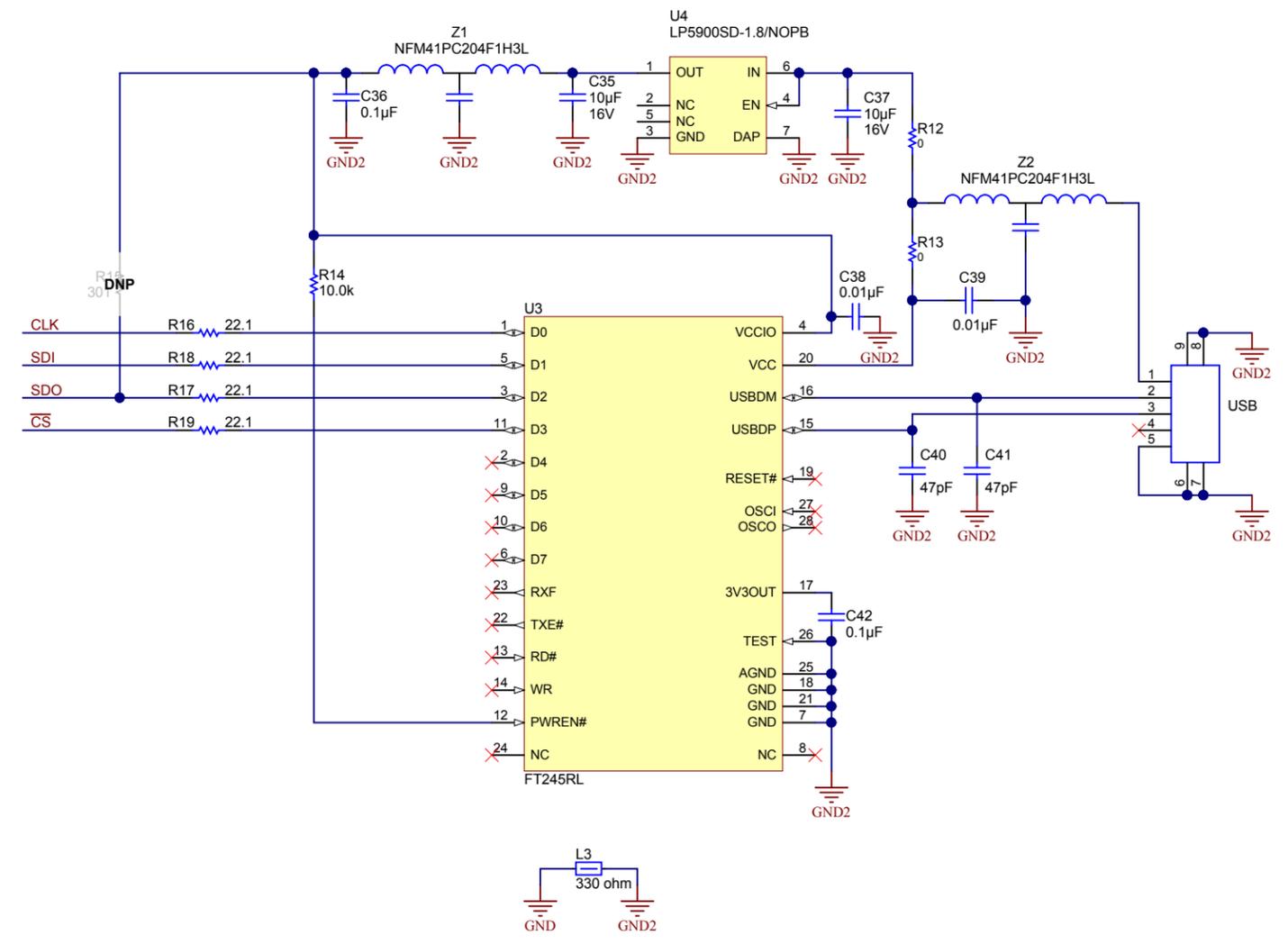
PCB Number:
PCB Rev: A

PCB LOGO
Texas Instruments
GND

DNP FID1
DNP FID2
DNP FID3

PCB LOGO
Pb-Free Symbol

PCB LOGO
FCC disclaimer



ZZ2
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2., unless otherwise specified.

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